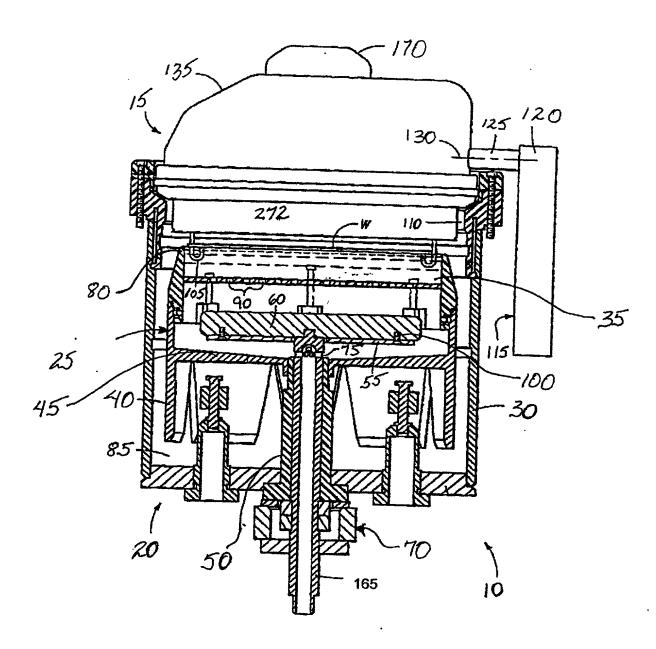
Title: METHOD FOR FILLING RECESSED MICROSTRUCTURES WITH METALLIZATION IN THE PRODUCTION OF A MICROELECTRONIC DEVICE

Inventors:
Docket No.:

T.L. Ritzdorf et al. SEMT117192

FIG. 1

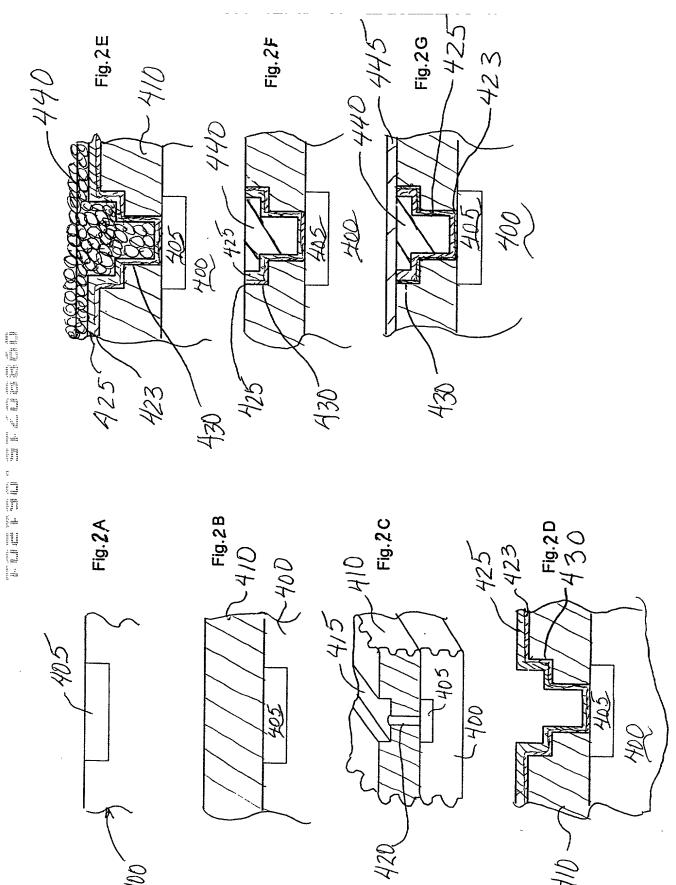


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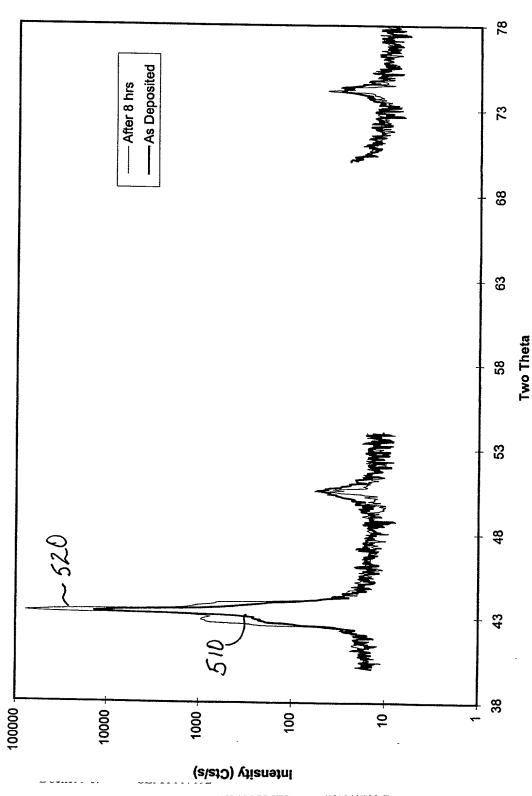
T.L. Ritzdorf et al. SEMT117192

Docket No.:



STRUCTURES WITH METALLIZATION IN THE LIGH: MELHOD FOR FILLING RECESSED MICRO-

Two Theta Coupled Scan

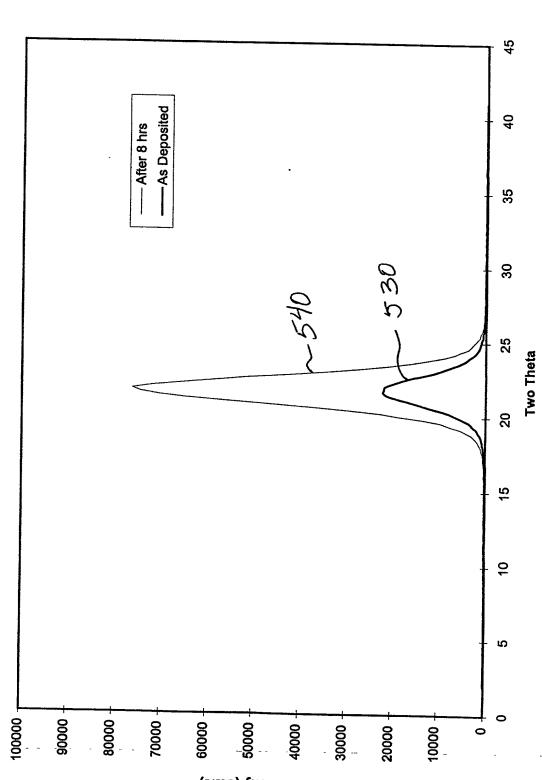


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Docket No.: SEMT117192



**Rocking Curve** 



SEMT117192 Intensity (Cts/s)

Inventors: T.L. Ritzdorf et al.

Docket No.: SEMT117192

PRODUCTION OF A MICROELECTRONIC DEVICE STRUCTURES WITH METALLIZATION IN THE TRUCTURE RECESSED MICRO-